

IXTH 14N100

= 1000 V

 $= 0.82 \Omega$

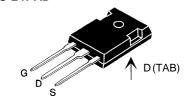
MegaMOS™FET

N-Channel Enhancement Mode



			•
Symbol	Test Conditions	Maximum	n Ratings
V _{DSS}	T _J = 25°C to 150°C	1000	V
V _{DGR}	$T_J = 25$ °C to 150°C; $R_{GS} = 1 \text{ M}\Omega$	1000	V
V _{GS}	Continuous	±20	V
V _{GSM}	Transient	±30	V
I _{D25}	T _c = 25°C	14	Α
I _{DM}	$T_{\rm C} = 25^{\circ}$ C, pulse width limited by $T_{\rm JM}$	56	Α
$\overline{P_{D}}$	T _C = 25°C	360	W
T _J		-55 + 150	°C
T_{JM}		150	°C
T_{stg}		-55 + 150	°C
M _d	Mountingtorque	1.13/10	Nm/lb.in.
Weight		6	g
	ead temperature for soldering 062 in.) from case for 10 s	300	°C





D = Drain, G = Gate, TAB = Drain S = Source,

Features

- International standard package JEDEC TO-247 AD
- Low R_{DS (on)} HDMOSTM process
 Rugged polysilicon gate cell structure
- Fast switching times

Symbol	Test Conditions $(T_{_{\rm J}}=2$	Ch 25°C, unless min.		ristic Va se speci max.	
V _{DSS}	$V_{GS} = 0 \text{ V}, I_D = 3 \text{ mA}$	1000			V
$V_{\rm GS(th)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	2		4.5	V
I _{GSS}	$V_{GS} = \pm 20 V_{DC}, V_{DS} = 0$			±100	nΑ
I _{DSS}	$V_{DS} = 0.8 \cdot V_{DSS}$ $T_{J} = 25^{\circ}$ $V_{GS} = 0 V$ $T_{J} = 125$			500 3	μA mA
R _{DS(on)}	$V_{GS} = 10 \text{ V}, I_D = 0.5 \bullet I_{D25}$ Pulse test, $t \le 300 \mu\text{s}, \text{ duty cycle d} \le 200 \mu\text{s}$	2%	0.70	0.82	Ω

Applications

- Switch-mode and resonant-mode power supplies
- · Motor controls
- Uninterruptible Power Supplies (UPS)
- · DC choppers

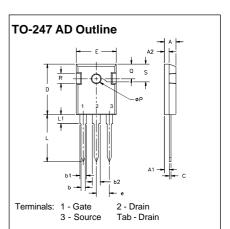
Advantages

- · Easy to mount with 1 screw (isolated mounting screw hole)
- Space savings
- High power density



Symbol	Test Conditions Characteristic Values (T ₁ = 25°C, unless otherwise specified)			
	min.	typ.	max.	,
g _{fs}	$V_{DS} = 10 \text{ V}; I_D = 7 \text{ A}, \text{ pulse test}$	10		S
C _{iss})	5650		рF
C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$	400		pF
\mathbf{C}_{rss}	J	150		pF
t _{d(on)})	24		ns
t _r	$V_{GS} = 10 \text{ V}, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 I_{D25}$	21		ns
$\mathbf{t}_{d(off)}$	$R_{\rm G} = 2 \Omega$, (External)	80		ns
t _f)	36		ns
$\mathbf{Q}_{g(on)}$)	195		nC
\mathbf{Q}_{gs}	$V_{GS} = 10 \text{ V}, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 I_{D25}$	28		nC
\mathbf{Q}_{gd}	J	85		nC
R _{thJC}			0.35	K/W
$R_{\rm thCK}$		0.25		K/W

Source-Dr		Characteristic Values $(T_1 = 25^{\circ}C, unless otherwise specified)$		
Symbol	Test Conditions min.	typ.	max.	ilicu)
I _s	V _{GS} = 0 V		14	Α
I _{sm}	Repetitive; pulse width limited by $T_{_{\rm JM}}$		56	Α
V _{SD}	$I_F = I_S$, $V_{GS} = 0$ V, Pulse test, t ≤ 300 μs, duty cycle d ≤ 2 %		1.5	V
t _{rr}	$I_F = I_S$, -di/dt = 100 A/ μ s, $V_R = 100 \text{ V}$	850		ns



Dim.	Millimeter		Inches	
	Min.	Max.	Min.	Max.
Α	4.7	5.3	.185	.209
A ₁	2.2	2.54	.087	.102
A_2	2.2	2.6	.059	.098
b	1.0	1.4	.040	.055
b ₁	1.65	2.13	.065	.084
b ₂	2.87	3.12	.113	.123
С	.4	.8	.016	.031
D	20.80	21.46	.819	.845
Е	15.75	16.26	.610	.640
е	5.20	5.72	0.205	0.225
L	19.81	20.32	.780	.800
L1		4.50		.177
ØP	3.55	3.65	.140	.144
Q	5.89	6.40	0.232	0.252
R	4.32	5.49	.170	.216
S	6.15	BSC	242	BSC